

# SPECIFICATIONS

Seven segment Display **数码管产品规格书**

# TOPLITE



**MODEL: TOP-CC-1055AUW**

|                       |  |  |
|-----------------------|--|--|
| 客户承认<br>APPROVED      |  |  |
| 承认日期<br>APPROVED DATE |  |  |

**上海鼎晖科技股份有限公司**

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APPROVED 批准: \_\_\_\_\_

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## TECHNICAL DATA SHEET

TOP- CC-1055AUW <FOR  $\Phi$ 3MM /5\*5 DOT MATRIX DIGITI>

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### 1. PRODUCT INTRODUCTION

- ※ Low power requirement,
- ※ Solid state reliability.
- ※ Wide viewing angle.
- ※ Easy mounting on P.C. boards.
- ※ RoHS compliant.

### 2. FEATURES

- ※ The TOP- CC-1055AUW is a 0.9 inch (22.8mm)matrix height 5×5 dot matrix display.
- ※ This device is made with pale yellow dots and black surface.

### 3. APPLICATION

- ※ Digital readout display.
- ※ Instrument panels.
- ※ Elevator.

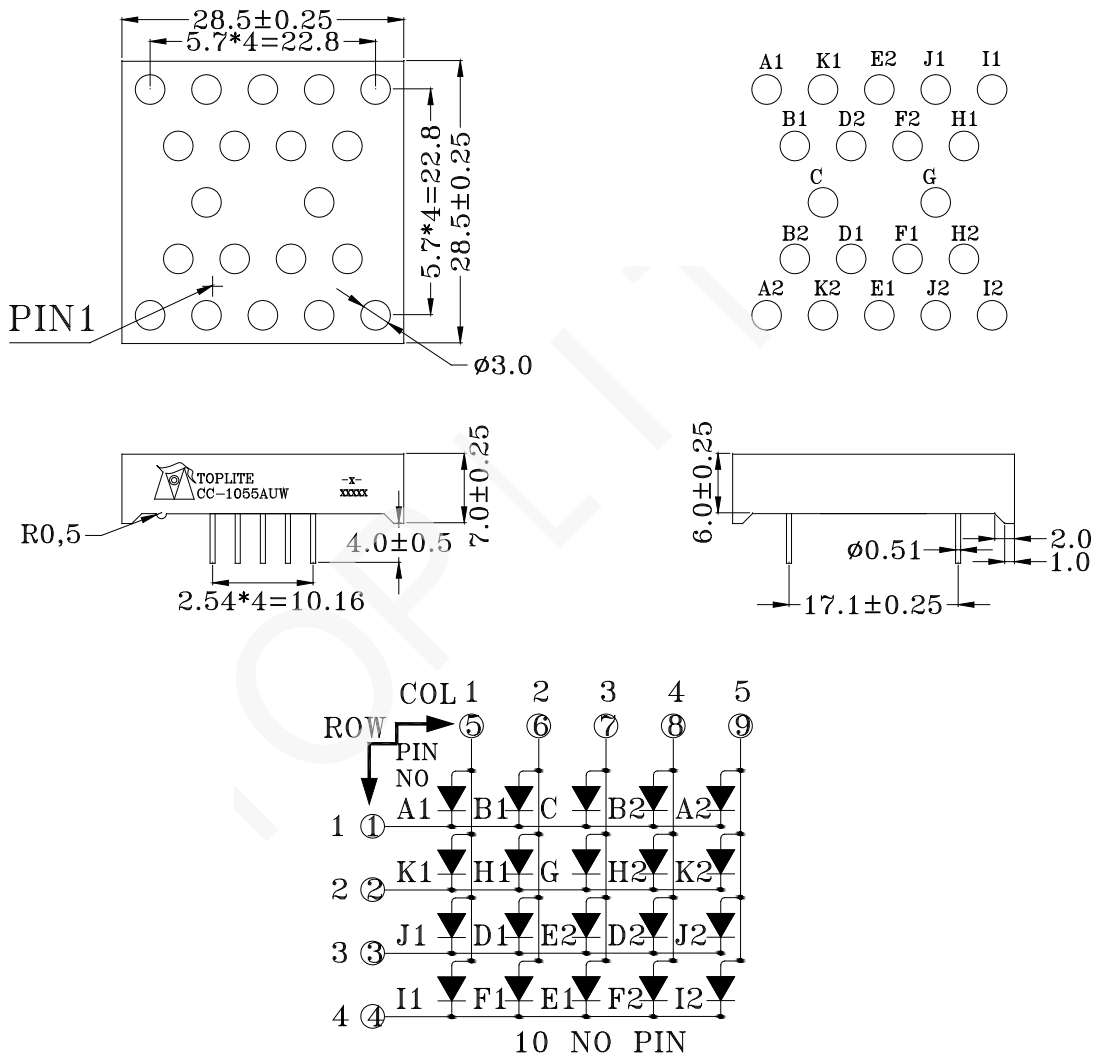
| PART NO.       | SIZE                                 | CHIP EMITTED COLOR | FACE COLOR |
|----------------|--------------------------------------|--------------------|------------|
| TOP-CC-1055AUW | $\Phi$ 3MM/ 5*5 DOT<br>MATRIX DIGITI | Blue               | Black      |

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### 4. PACKAGE DIMENSIONS & CIRCUIT DIAGRAM



Note:

All dimension tolerance is  $\pm 0.25$ mm unless otherwise noted.

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**5. ELECTRICAL/OPTICAL CHARACTERISTIC**
**5-1. ABSOLUTE MAXIMUM RATINGS (Ta=25°C)**

| PARAMETER                              | SYMBOL     | VALUE       | UNIT      |
|--|------------|-------------|-----------|
| Reverse Voltage                        | $V_R$      | 5           | V/dot*    |
| Forward Current                        | $I_F$      | 20          | mA/ dot * |
| Peak Forward Current (1/10 Duty Cycle) | $I_{PEAK}$ | 120         | mA/ dot * |
| Power Dissipation                      | $P_D$      | 80          | mW/ dot * |
| Operating Temperature Range            | $T_A$      | - 25 ~ + 85 | °C        |
| Storage Temperature Range              | $T_{STG}$  | - 30~ + 85  | °C        |
| Solder Temperature                     | $T_{sol}$  | 260/3       | °C/s      |

**5-2. ELECTRICAL-OPTICAL CHARACTERISTICS (Ta=25°C)**

| PARAMETER                | SYMBOL           | MIN. | TYP.  | MAX.  | UNIT     | TEST CONDITIONS |            |
|--------------------------|------------------|------|-------|-------|----------|-----------------|------------|
| Luminous Intensity       | $I_V$            | T    | 26325 | 32907 | 39489    | ucd             | $I_F=10mA$ |
|                          |                  | U    | 39490 | 49362 | 59235    |                 |            |
|                          |                  | V    | 59236 | 74045 | 88854    |                 |            |
| Forward Voltage          | $V_F$            | 2.8  | 3.2   | 3.5   | v/ dot * | $I_F=20mA$      |            |
| Color temperature        | TC               | 7000 | -     | 10000 | K        | $I_F=20mA$      |            |
| Spectral Line Half-Width | $\Delta \lambda$ | -    | 30    | -     | nm       | $I_F=20mA$      |            |
| Reverse Current          | $I_R$            | -    | -     | 20    | uA       | $V_R=5v$        |            |

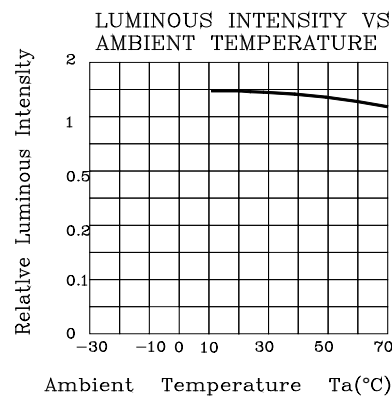
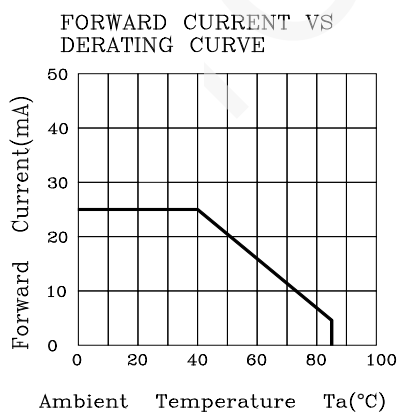
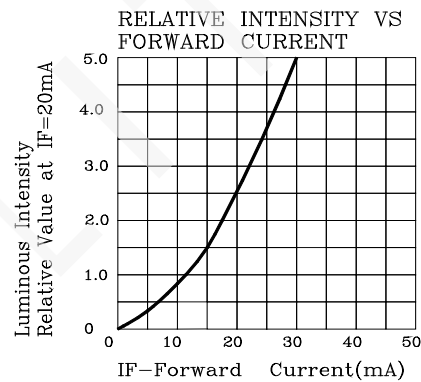
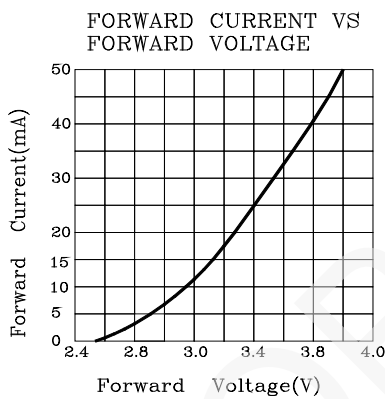
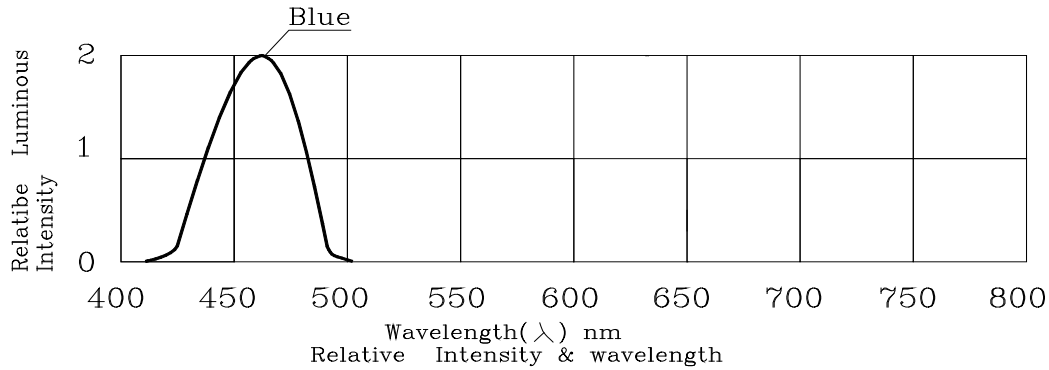
\*The dot represents a chip.Each segment according to the principle diagram calculation of voltage and current.

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### 5-3. OPTICAL CHARACTERISTIC CURVES





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### 6. QUALITY CONTROL AND ASSURANCE

| CLASSIFICATION     | TEST ITEM   | TEST CONDITION  |
|--------------------|---|---|
| ENDURANCE TEST     | OPERATION LIFE                                    | Ta= Natural temperature<br>If=12mA-25mA per dot or Ip=80mA/duty=1/8,Pw=1.25mS<br>Ip=160mA/duty=1/16,Pw=1.mS(DOT)<br>Test time=1000HRS(-24HRS+72HRS)             |
|                    | HIGH TEMPERATURE<br>HIGH HUMIDITY<br>STORAGE      | Evaluate storage time of the device under high temperature and high humidity<br>Ta=65°C±5°C RH=90-95% Test time=240HRS±2HRS                                     |
|                    | HIGH TEMPERATURE<br>HIGH HUMIDITY<br>REVERSE BIAS | Evaluate leakage current of the device under high temperature and high humidity<br>Ta=65°C±5°C RH=90-95% VR=5V<br>Test time=500hrs(-24HRS+48HRS)                |
|                    | HIGH TEMPERATURE<br>STORAGE                       | Evaluate reliability test of the device under high temperature<br>Ta=85°C±5°C Test time=1000HRS(-24HRS+72HRS)   |
|                    | LOW TEMPERATURE<br>STORAGE                        | Evaluate reliability test of the device under low temperature<br>Ta=-35°C±5°C Test time=1000HRS(-24HRS+72HRS)   |
| ENVIRONMENTAL TEST | TEMPERATURE<br>CYCLING                            | Evaluate thermal expansion and cold contraction of the device under harsh temperature<br>Ta=85°C~25°C~-35°C~25°C time=30min 5min 30min 5min Cycle test:10cycles |
|                    | THERMAL SHOCK                                     | Evaluate structural and mechanical of the device under sudden thermal shock<br>Ta=85°C±5°C~-35°C±5°C time=10min 10min Cycle test:10cycles                       |
|                    | SOLOER RESISTANCE                                 | Evaluate performance of the device withstand thermal shock during soldering<br>T.sol=260°C±5°C time=10±1sec   |
|                    | SOLOER ABILITY                                    | Evaluate solderability of the device<br>T.sol=230°C±5°C time=5±1sec   |

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### 7. SOLDERING CONDITIONS

The recommended conditions for soldering are as follows.

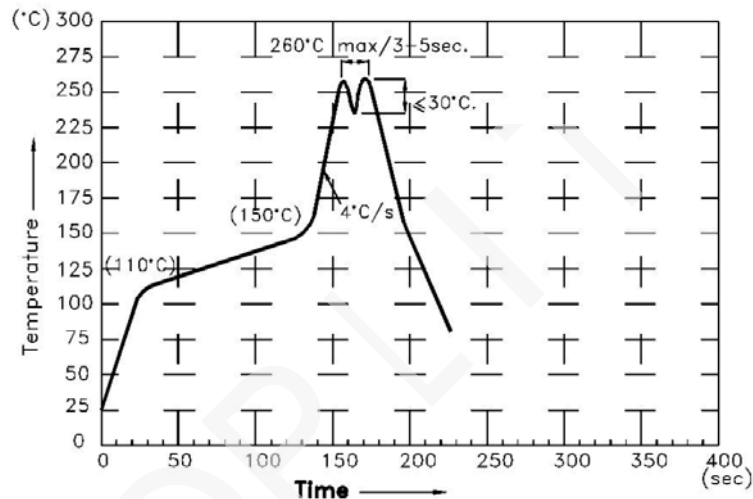
Because the component is made with epoxy resin, the units are susceptible to heat. Therefore, the preheating and soldering temperatures should be kept as low as possible to avoid damage.

#### 7-1. Manual Soldering Conditions(with 1.5mm Iron tip ).

Iron Tip Temperature: 350°C Max, Time: 3s Max.

Position: The iron should be situated at least 2mm away from the root of the leads.

#### 7-2. Through the Wave Soldering Conditions Wave Soldering Profile For Lead-free Through-hole LED.



#### 7-3. Soldering General Notes:

- Recommend manual soldering to be used only for repair and rework purposes. The soldering iron should not exceed 30W in power. The tip of the soldering iron should not touch the reflector case to avoid heat-damage.
- Maintain the pre-heat and peak temperatures with dip units as low as possible and the times as short as is feasible, since the products are susceptible to heat during flow soldering.
- After soldering, least three minutes for the component to cool to room temperature before further operations.
- If components will undergo multiple soldering processes, or other processes where the components may be subjected to intense heat, please check with toplight for compatibility.



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### 8. Customer optional

※This is a TOPLITE standard specifications(no protective film, TOPLITE printing code).If you have special request, please make the following choices.

8-1. **protetive film**       add protetive film       do not add protetive film

protetive film left side    \_\_\_\_mm       other

※protective film thickness standard is 0.1 mm.

8-2. **printing code**       TOPLITE standard printing code

Special printing code \_\_\_\_\_

Other \_\_\_\_\_

8-3. **Whether need products with group**

YES \_\_\_\_\_  NO \_\_\_\_\_  Other \_\_\_\_\_

8-4. **Other requirements**

a. \_\_\_\_\_

b. \_\_\_\_\_

c. \_\_\_\_\_